TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC4021BP,TC4021BF,TC4021BFN

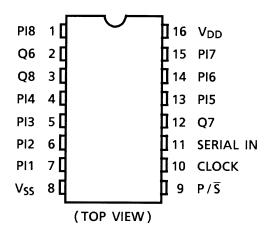
TC4021B 8-Stage Static Shift Register

(asynchronous parallel input or synchronous serial input/serial output)

TC4021B is 8 stage parallel in/serial out shift register, which can be used also for serial in/serial out operations. In the case of parallel operation, the data of PARALLEL IN is input to each F/F asynchronously with CLOCK and the output is obtained. In the case of serial operations, each F/F is triggered by rising edge of CLOCK. (asynchronous parallel or synchronous serial input)

Switching of PARALLEL operation and SERIAL operation is achieved by P/\overline{S} CONTROL input. When P/\overline{S} CONTROL input is "H", PARALLEL operation is designated and when it is "L", SERIAL operation is designated.

Pin Assignment



Truth Table

	Outputs∆						
	P/S	PI1	Pln	SI	Q1	Qn	
	L	*	*	L	L	Qn – 1	
	L	*	*	Н	Н	Qn – 1	
	L	*	*	*	No Change		
*	Н	L	L	*	L	L	
*	Н	L	Н	*	L	Н	
*	Н	Н	L	*	Н	L	
*	Н	Н	Н	*	Н	Н	

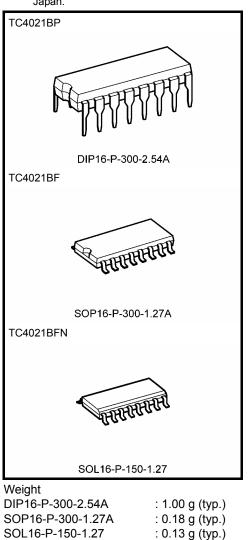
n: 2~8

∆: Q1~Q5 internal

 $\Delta\Delta$: Level change

*: Don't care

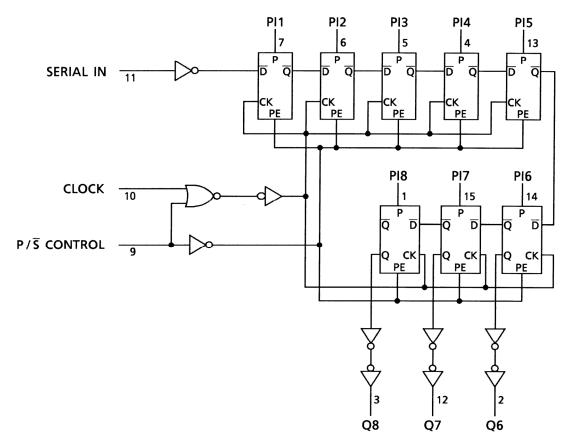
Note: xxxFN (JEDEC SOP) is not available in Japan.



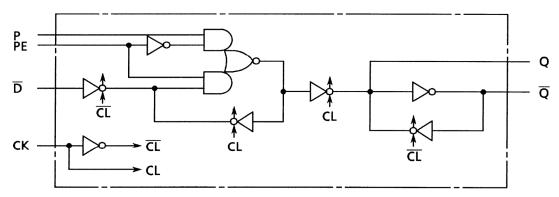
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Logic Diagram

Parallel



Internal Flip Flop



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
DC supply voltage	V _{DD}	$V_{SS} - 0.5 V_{SS} + 20$	V
Input voltage	V _{IN}	V _{SS} - 0.5~V _{DD} + 0.5	V
Output voltage	V _{OUT}	V _{SS} - 0.5~V _{DD} + 0.5	V
DC input current	I _{IN}	±10	mA
Power dissipation	PD	300 (DIP)/180 (SOIC)	mW
Operating temperature range	T _{opr}	-40~85	°C
Storage temperature range	T _{stg}	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (V_{SS} = 0 V) (Note)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
DC supply voltage	V _{DD}	—	3	_	18	V
Input voltage	V _{IN}	—	0	_	V _{DD}	V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{DD} or V_{SS} .

Static Electrical Characteristics ($V_{SS} = 0 V$)

		Sym-	Test Condition		-40°C		25°C			85°C			
Charac	teristics	bol		V _{DD} (V)	Min	Max	Min	Тур.	Max	Min	Max	Unit	
			5	4.95	_	4.95	5.00	_	4.95	_			
High-level voltage	output	VOH	I _{OUT} < 1 μΑ V _{IN} = V _{SS} , V _{DD}	10	9.95	—	9.95	10.00	—	9.95	—	V	
0			VIN – VSS, VDD	15	14.95	_	14.95	15.00	_	14.95	_		
			I _{OUT} < 1 μΑ	5		0.05	_	0.00	0.05		0.05		
Low-level voltage	output	VOL	$V_{IN} = V_{SS}, V_{DD}$	10	—	0.05	—	0.00	0.05		0.05	V	
Ū			VIN - VSS, VDD	15	_	0.05	—	0.00	0.05		0.05		
			V _{OH} = 4.6 V	5	-0.61	—	-0.51	-1.0	—	-0.42	—	mA	
			$V_{OH} = 2.5 V$	5	-2.50	_	-2.10	-4.0	—	-1.70	—		
Output hig	h current	IOH	V _{OH} = 9.5 V	10	-1.50	_	-1.30	-2.2	—	-1.10	—		
			V _{OH} = 13.5 V	15	-4.00	_	-3.40	-9.0	—	-2.80	—		
			$V_{IN}=V_{SS},\ V_{DD}$										
			$V_{OL} = 0.4 V$	5	0.61		0.51	1.5		0.42			
Output low current	I _{OL}	$V_{OL} = 0.5 V$	10	1.50	—	1.30	3.8	—	1.10	—	mA		
		V _{OL} = 1.5 V	15	4.00	—	3.40	15.0	—	2.80	—			
		$V_{IN}=V_{SS},\ V_{DD}$											
		V _{IH}	$V_{OUT} = 0.5 V, 4.5 V$	5	3.5	_	3.5	2.75	_	3.5	_	v	
Input high	voltago		V _{OUT} = 1.0 V, 9.0 V	10	7.0	—	7.0	5.50	—	7.0	—		
input nigh	voltage		V _{OUT} = 1.5 V, 13.5 V	15	11.0	—	11.0	8.25	—	11.0	—		
			$ I_{OUT} < 1 \ \mu A$										
			$V_{OUT} = 0.5 V, 4.5 V$	5	_	1.5	_	2.25	1.5		1.5		
Inputiows	voltago	Ma	V _{OUT} = 1.0 V, 9.0 V	10	—	3.0	—	4.50	3.0		3.0	V	
Input low voltage		VIL	$V_{OUT} = 1.5 V, 13.5 V$	15	—	4.0	—	6.75	4.0		4.0	v	
			$ I_{OUT} < 1 \ \mu A$										
Input	"H" level	IIH	V _{IH} = 18 V	18		0.1	_	10 ⁻⁵	0.1		1.0		
current	"L" level	١ _{IL}	$V_{IL} = 0 V$	18		-0.1	_	-10 ⁻⁵	-0.1		-1.0	μA	
		y I _{DD}	$V_{IN} = V_{SS}, V_{DD}$	5		5	_	0.005	5		150		
Quiescent current	supply			10	—	10	—	0.010	10		300	μA	
-	ounon		(Note)	15	_	20	_	0.020	20		600		

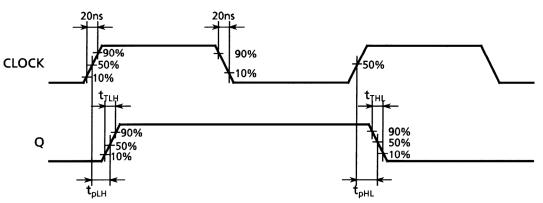
Note: All valid input combinations.

Dynamic Electrical Characteristics (Ta = 25° C, V_{SS} = 0 V, C_L = 50 pF)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Characteristics	Symbol		V _{DD} (V)	Min			
Output transition time			5	_	80	200	
(low to high)	t _{TLH}	—	10	—	50	100	ns
			15	_	40	80	
Output transition time			5	—	80	200	
(high to low)	t _{THL}	—	10	—	50	100	ns
			15		40	80	
Propagation delay time	+		5	—	150	320	ns
(CLOCK-Q)	t _{pLH}	—	10	—	65	160	
(CEOCK-Q)	t _{pHL}		15	_	45	120	
Propagation delay time	+		5	—	230	460	ns
$(P/\overline{S} - Q)$	t _{pLH}	—	10	—	90	180	
	t _{pHL}		15		60	120	
			5	3.0	6.5		MHz
Max clock frequency	f _{CL}	—	10	6.0	18.0	—	
			15	8.5	24.0	—	
			5	—	80	180	
Min clock pulse width	t _W	_	10	—	30	80	ns
			15	_	20	50	
Max clock rise time	t _{rCL}		5	20.0	—	—	μs
Max clock fall time	t _{fCL}	_	10	2.5	—	—	
			15	1.0	—	—	
Min set-up time			5	—	40	120	ns
(SI-CLOCK)	t _{SU}		10	—	20	80	
			15	_	15	60	
Min set-up time			5	—	25	50	
(PI-P/S)	tsu	—	10	—	15	30	ns
()			15		10	20	
Min hold time		_	5	—	35	70	
(SI-CLOCK), (PI- P/\overline{S})	t _H		10	—	20	40	ns
			15		15	30	
Min pulse width			5	—	90	180	
$(P/\overline{S} - CONTROL)$	twн	—	10	—	30	80	ns
/			15		10	50	
Min removal time			5	—	45	280	
(P/S -CLOCK)	t _{rem}	—	10	—	20	140	ns
			15	—	15	100	
Input capacitance	C _{IN}	—		_	5	7.5	pF

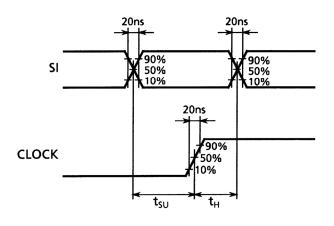
Waveforms for Measurement of Dynamic Characteristics

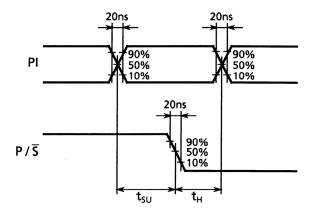
Waveform 1



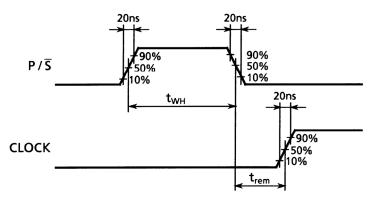
Waveform 2

Waveform 3

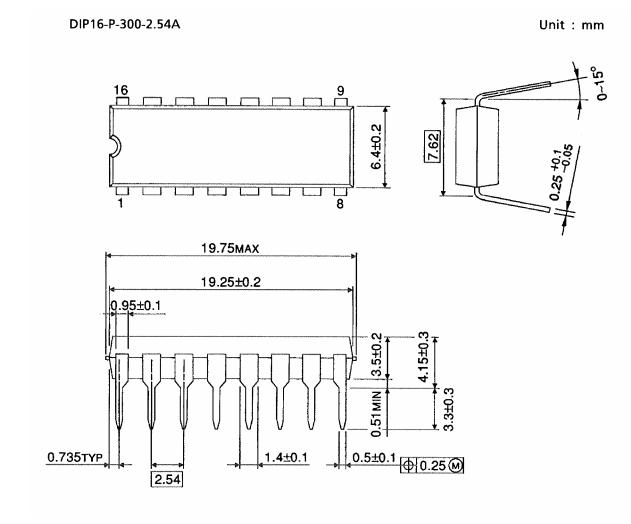




Waveform 4



Package Dimensions



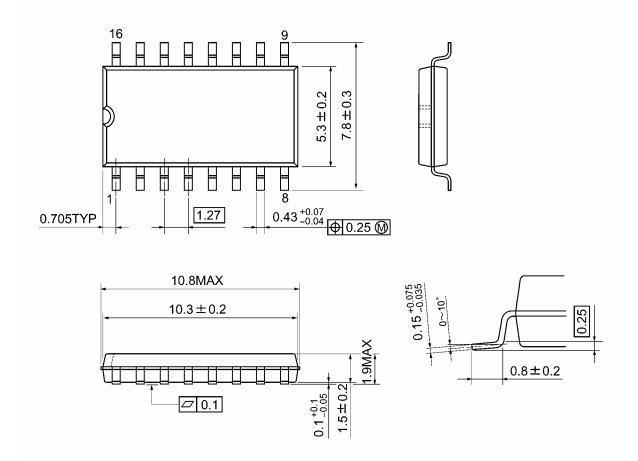
Weight: 1.00g (typ.)



Package Dimensions

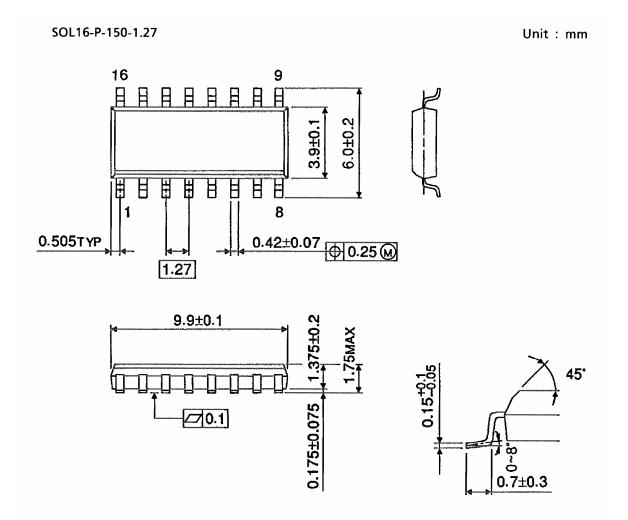
SOP16-P-300-1.27A

Unit: mm



Weight: 0.18 g (typ.)

Package Dimensions (Note)



Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

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20070701-EN GENERAL

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